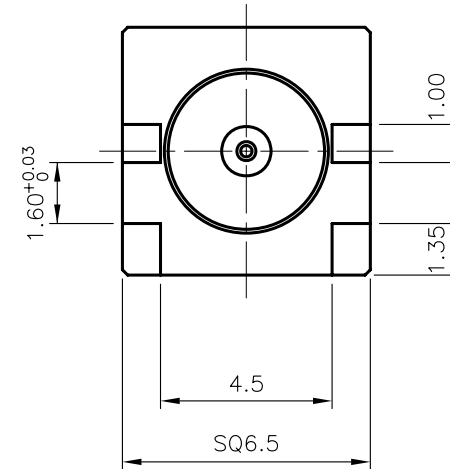
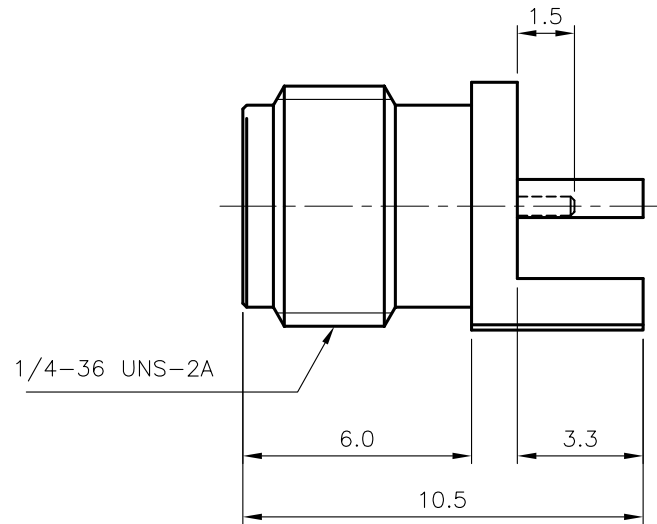
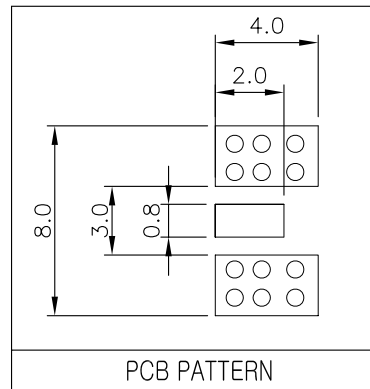


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	G.Y.KIM	I.C.KIM	2016. 12. 23.



■포장사양 (4번)

- 1.부광하이텍 327-3호(PET) Tray 사용
2. Tray 개당 제품 5EA씩 포장하여 Total 250EA 포장



3	INSULATOR	1	TEFLON		DIN02191-N/2
2	CONTACT	1	BeCu C17300	Gold Plate	DCT02858-5/2
1	BODY	1	MBsBD C3604BD-F	Gold Plate	DBD03350-5/2
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2016. 12. 23.			 KJ COMTECH CO.,LTD.	RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017		
	Angle	APPROVED BY		I.C.KIM		TITLE SMA50 PCB JS-4R (edge)		
	±1°	CHECKED BY		C.K.KIM				
MATERIAL		DRAWN BY		G.Y.KIM	A4			
FINISH		SCALE	UNIT					
		5/1	mm		REVISION		I R	SHEET 1 of 1